

V_R	650V
I_F	15A/30A*
Q_C	23nC(Per leg)

(*Per leg/ Both legs)

●Features

- 1) AEC-Q101 qualified
- 2) Low forward voltage
- 3) Negligible recovery time/current
- 4) Temperature independent switching behavior

●Applications

- On Board Charger
- DC/DC Converter
- Wireless Charger
- EV Charger

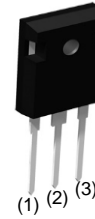
●Absolute maximum ratings ($T_{vj} = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit	
Reverse voltage (repetitive peak)	V_{RM}	650	V	
Reverse voltage (DC)	V_R	650	V	
Continuous forward current *3 ($T_c = 134^\circ\text{C}$)	I_F	15/30	A	
Surge non-repetitive forward current *3	I_{FSM}	PW=10ms sinusoidal, $T_{vj}=25^\circ\text{C}$	52/100	A
		PW=10ms sinusoidal, $T_{vj}=150^\circ\text{C}$	41/82	A
		PW=10μs square, $T_{vj}=25^\circ\text{C}$	200/400	A
Repetitive peak forward current *3	I_{FRM}	65/130*1	A	
i ² t value*3	$\int i^2 dt$	PW=10ms, $T_{vj}=25^\circ\text{C}$	13/55	A ² s
		PW=10ms, $T_{vj}=150^\circ\text{C}$	8.4/33	A ² s
Total power dissipation *3	P_D	110/230*2	W	
Virtual Junction temperature	T_{vj}	175	°C	
Range of storage temperature	T_{stg}	-55 to +175	°C	

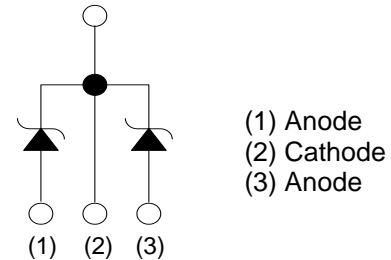
*1 $T_c=100^\circ\text{C}$, $T_{vj}=150^\circ\text{C}$, Duty cycle=10% *2 $T_c=25^\circ\text{C}$ *3 Per leg/ Both legs

●Outline

TO-247N



●Inner circuit



●Packaging specifications

Package	TO-247N	
Type	Packing	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	30
	Packing code	C11
	Marking	SCS230AE2

●Electrical characteristics ($T_{vj} = 25^{\circ}\text{C}$) (Per Leg)

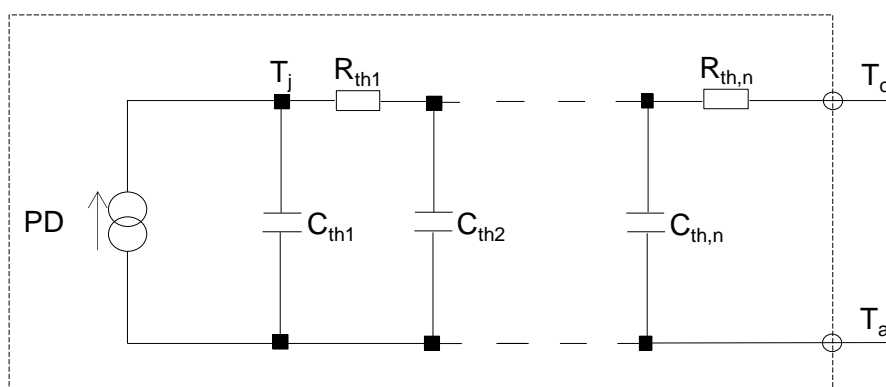
Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
DC blocking voltage	V_{DC}	$I_R=3.0\text{mA}$	650	-	-	V
Forward voltage	V_F	$I_F=15\text{A}, T_{vj}=25^{\circ}\text{C}$	-	1.35	1.55	V
		$I_F=15\text{A}, T_{vj}=150^{\circ}\text{C}$	-	1.55	-	V
		$I_F=15\text{A}, T_{vj}=175^{\circ}\text{C}$	-	1.63	-	V
Reverse current	I_R	$V_R=650\text{V}, T_{vj}=25^{\circ}\text{C}$	-	3	300	μA
		$V_R=650\text{V}, T_{vj}=150^{\circ}\text{C}$	-	45	-	μA
		$V_R=650\text{V}, T_{vj}=175^{\circ}\text{C}$	-	105	-	μA
Total capacitance	C	$V_R=1\text{V}, f=1\text{MHz}$	-	550	-	pF
		$V_R=600\text{V}, f=1\text{MHz}$	-	56	-	pF
Total capacitive charge	Q_C	$V_R=400\text{V}, di/dt=350\text{A}/\mu\text{s}$	-	23	-	nC
Switching time	t_C	$V_R=400\text{V}, di/dt=350\text{A}/\mu\text{s}$	-	18	-	ns

●Thermal characteristics

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance	R_{thJC}	Per Leg	-	1.1	1.3	K/W
		Both Legs	-	0.55	0.63	K/W

●Typical Transient Thermal Characteristics (Per Leg)

Symbol	Value	Unit	Symbol	Value	Unit
R_{th1}	2.90×10^{-1}	K/W	C_{th1}	2.33×10^{-3}	Ws/K
R_{th2}	8.03×10^{-1}		C_{th2}	8.15×10^{-3}	
R_{th3}	8.54×10^{-3}		C_{th3}	5.82×10^{-1}	



●Electrical characteristic curves

Fig.1 $V_F - I_F$ Characteristics (Per Leg)

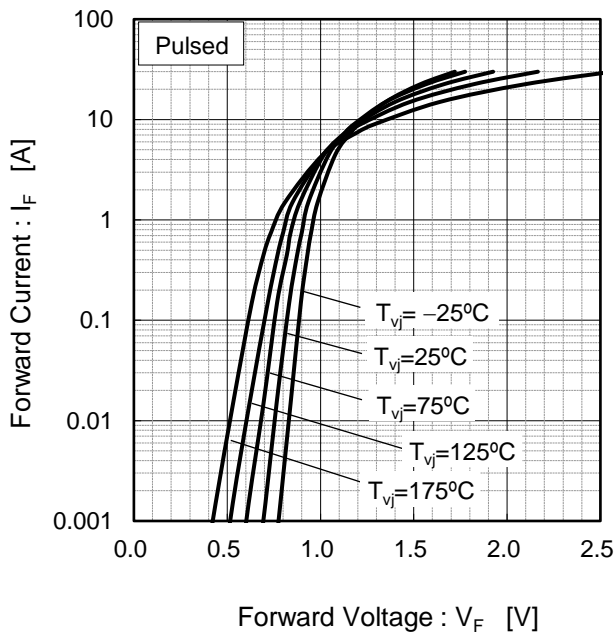


Fig.2 $V_F - I_F$ Characteristics (Per Leg)

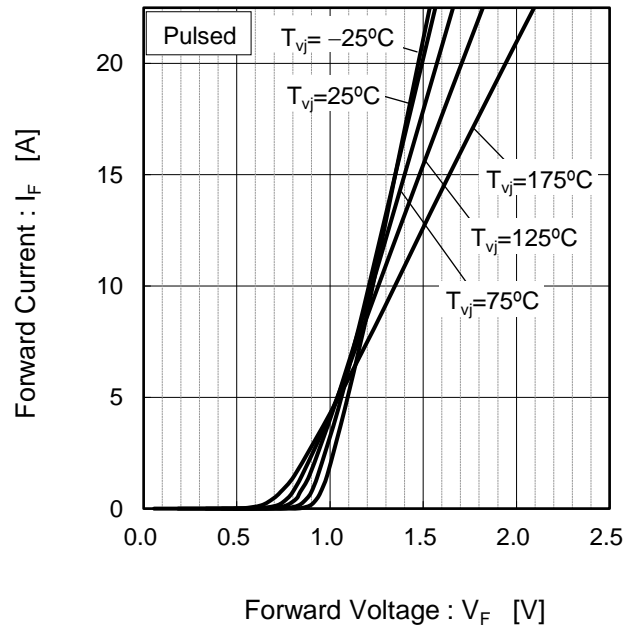


Fig.3 $V_R - I_R$ Characteristics (Per Leg)

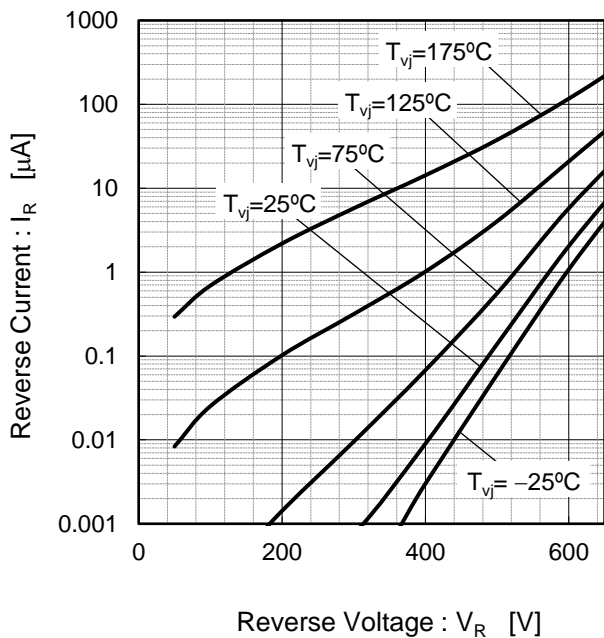
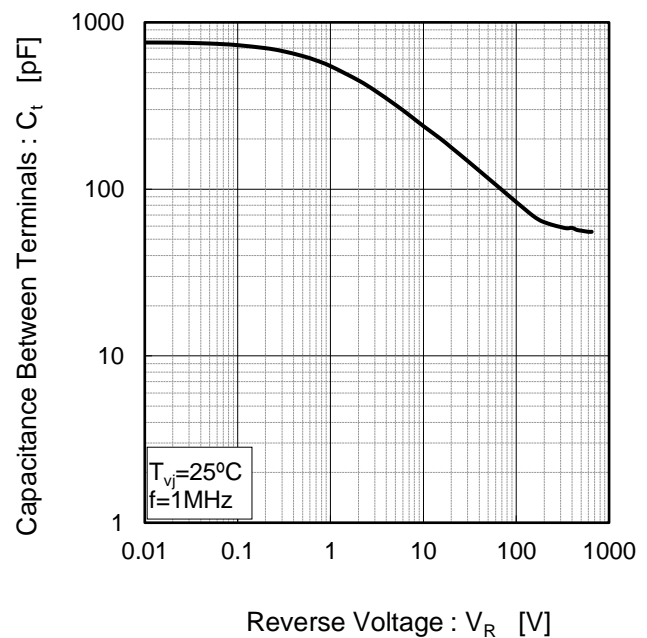


Fig.4 $V_R - C_t$ Characteristics (Per Leg)



●Electrical characteristic curves

Fig.5 Typical Transient Thermal Impedance vs. Pulse Width (Per Leg)

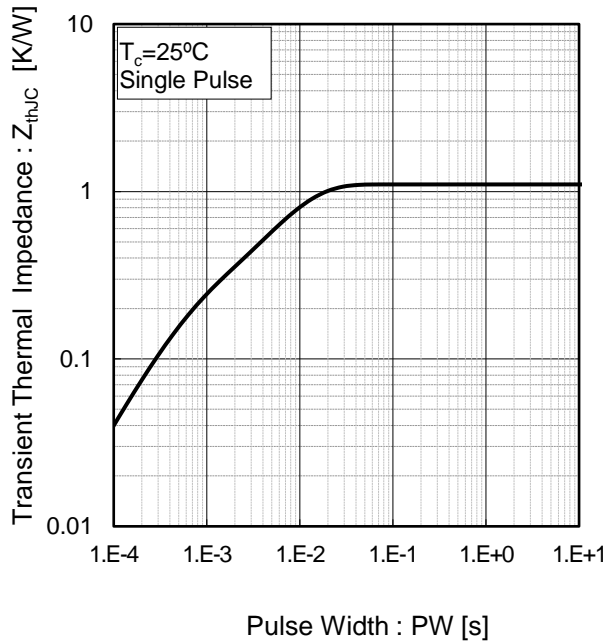


Fig.6 Power Dissipation (Per Leg)

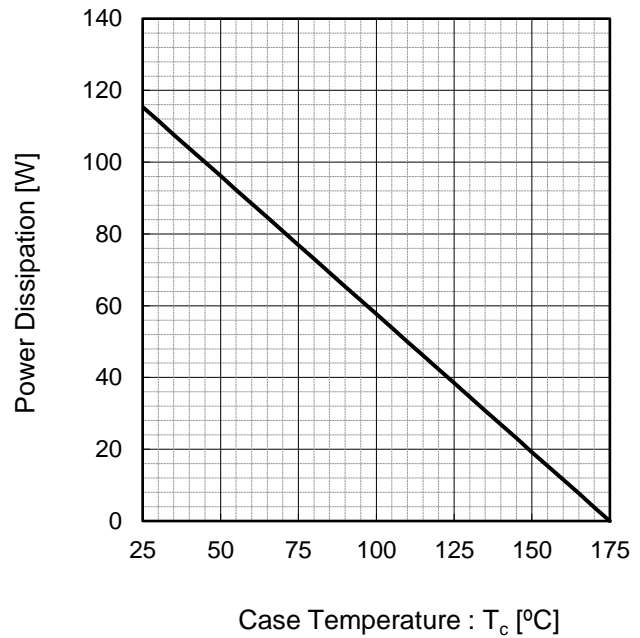
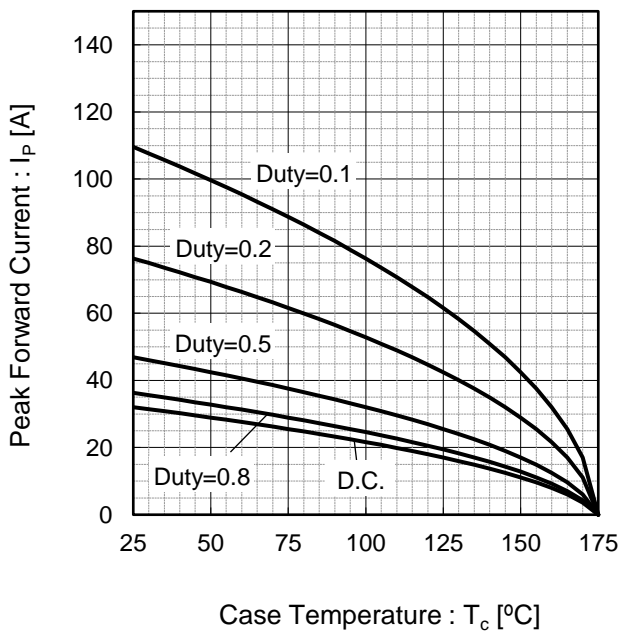
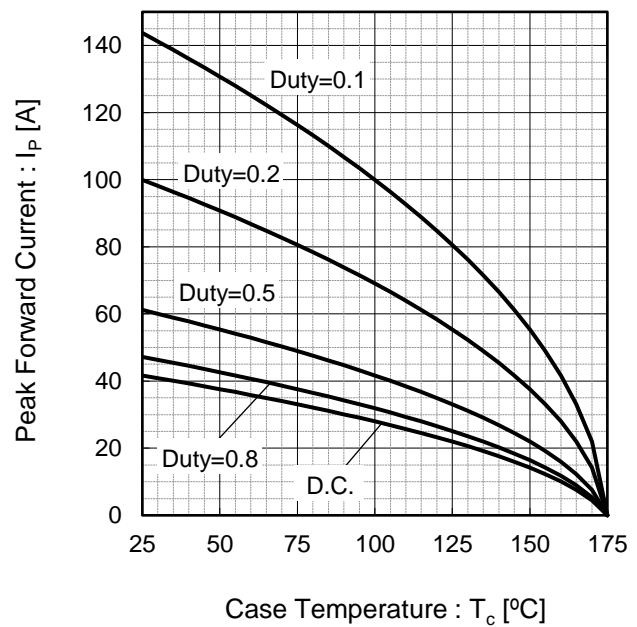


Fig.7*4 Maximum peak forward current derating curve $I_P - T_c$ (Per Leg)



*4 Based on max Vf, max R_{thJC}
Valid for switching of above 10kHz,
excluding D.C. curve.

Fig.8*5 Typical peak forward current derating curve $I_P - T_c$ (Per Leg, Not guaranteed)



*5 Based on typ Vf, typ R_{thJC}
Typical value, not guaranteed
Valid for switching of above 10kHz,
excluding D.C. curve

●Electrical characteristic curves

Fig.9 Surge non-repetitive forward current vs. Pulse width (Sinusoidal waveform) (Per Leg)

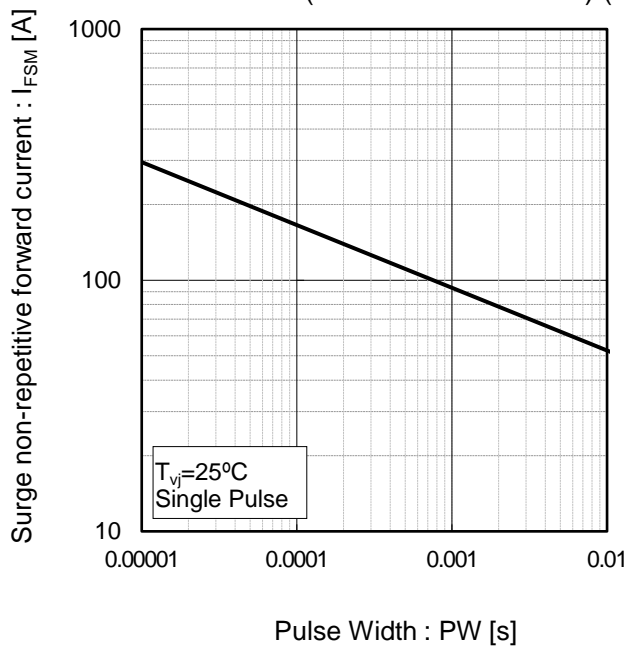
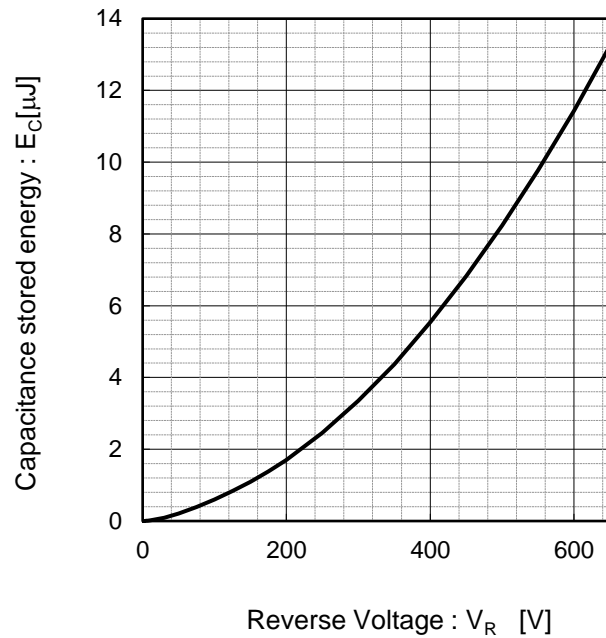
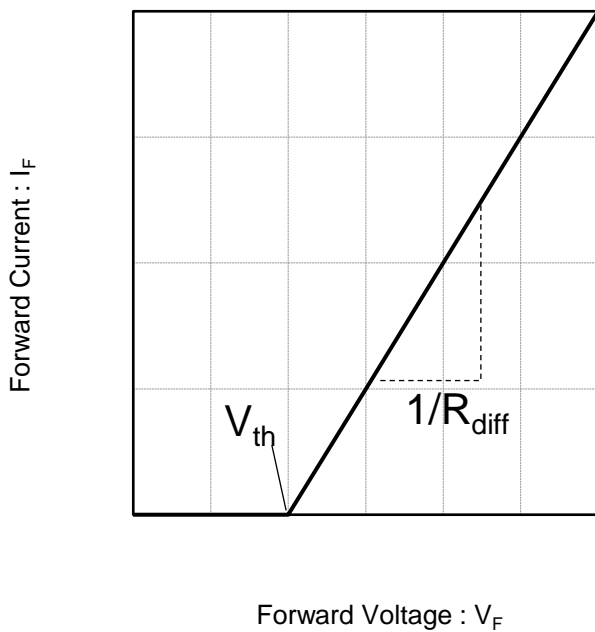


Fig.10 Typical capacitance store energy (Per Leg)



●Simplified forward characteristic model (Per Leg)

Fig.11 Equivalent forward current curve



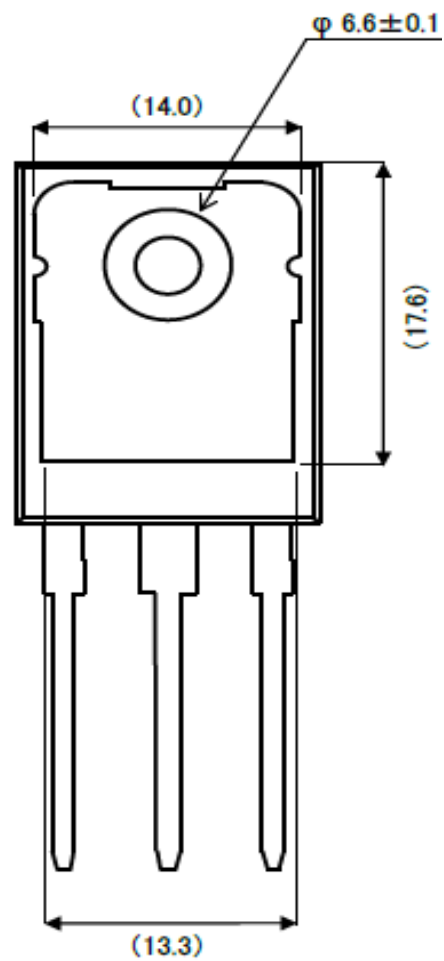
$$V_F = V_{th} + R_{diff} I_F$$

$$V_{th}(T_{vj}) = a_0 + a_1 T_{vj}$$

$$R_{diff}(T_{vj}) = b_0 + b_1 T_{vj} + b_2 T_{vj}^2$$

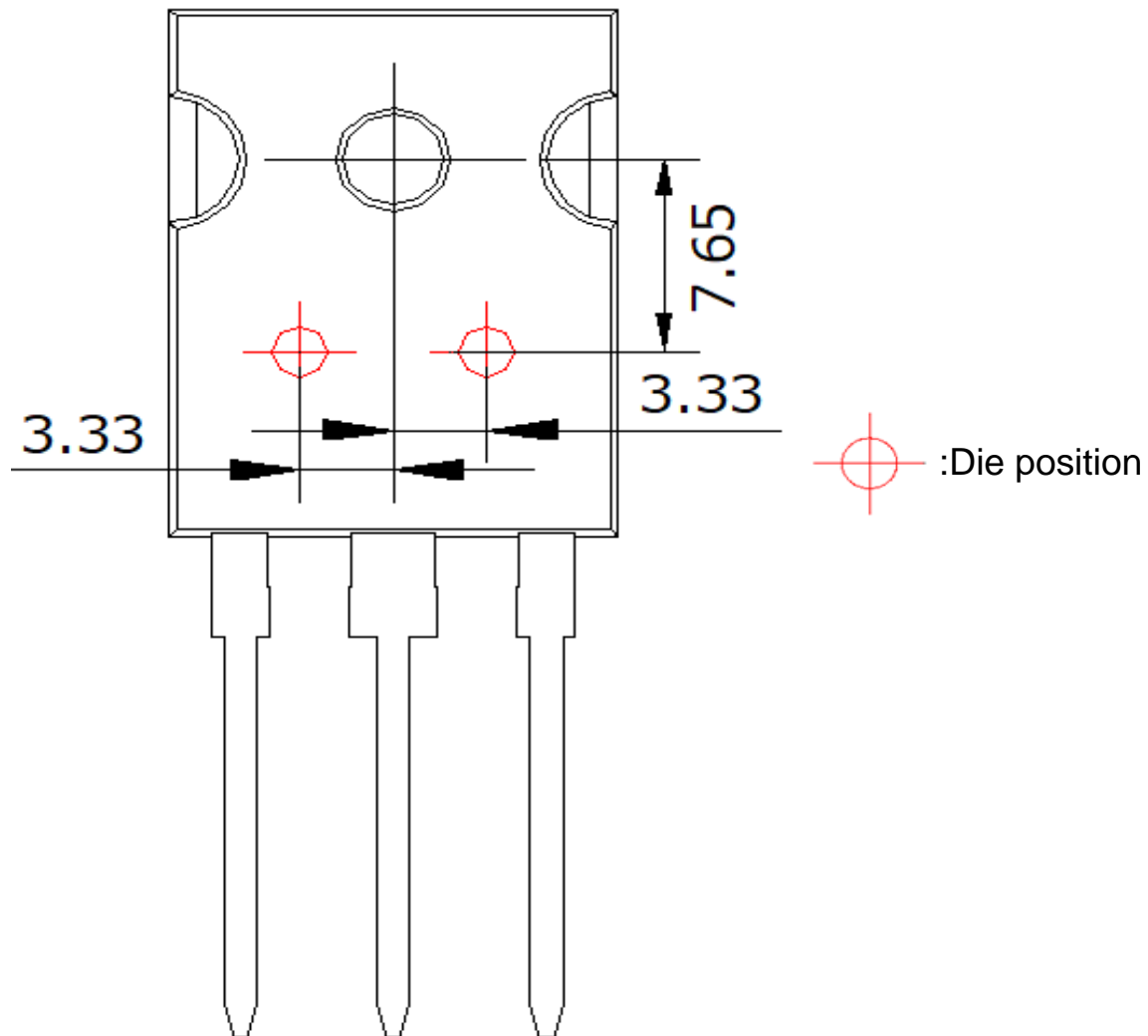
Symbol	Typical Value	Unit
a_0	9.35×10^{-1}	V
a_1	-1.12×10^{-3}	V/°C
b_0	2.65×10^{-2}	Ω
b_1	6.80×10^{-5}	Ω/°C
b_2	7.20×10^{-7}	Ω/°C ²

T_{vj} in °C; $-55\text{ °C} < T_{vj} < 175\text{ °C}$; $I_F < 30\text{ A}$



Unit: mm

●Die Bonding Layout



- Front view of the packaging.
- Dimensions are design values.
- If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm